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Characterization of Lamination Progress with Ultrasound

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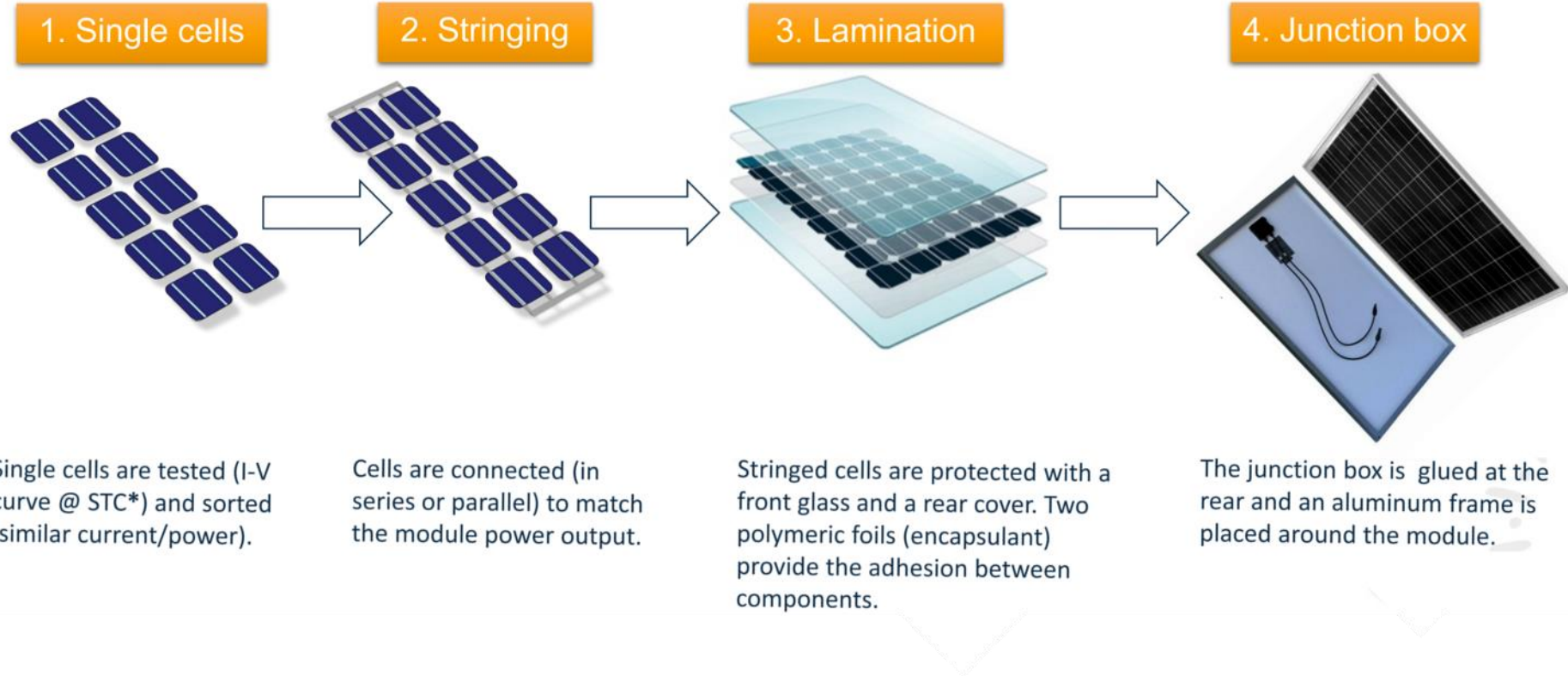
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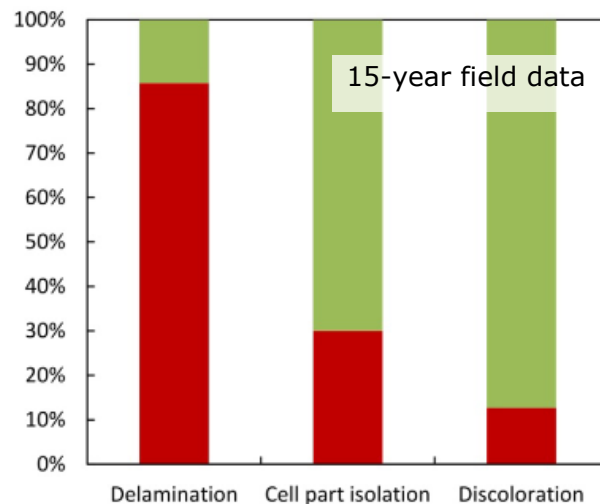
Module Manufacturing



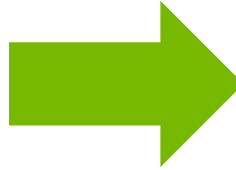
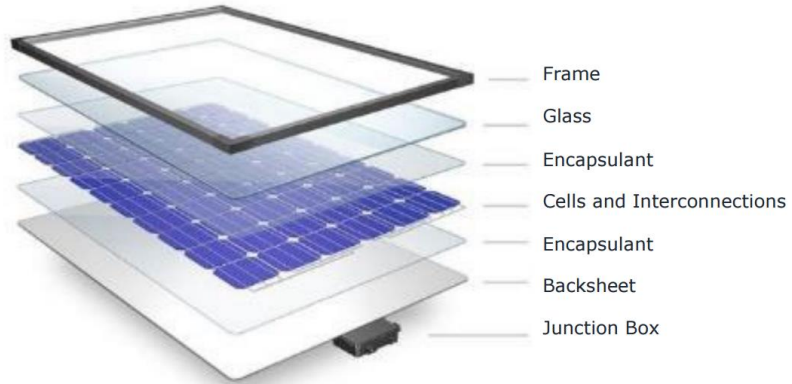
Delamination is an Important Failure Mode

Tasks of the encapsulation:

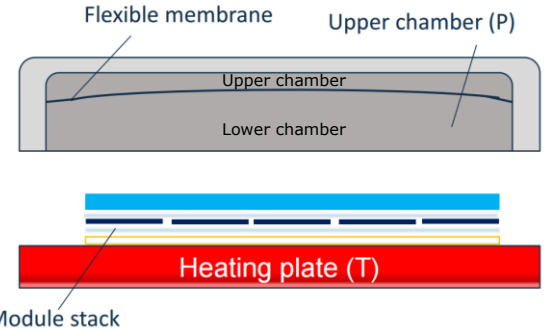
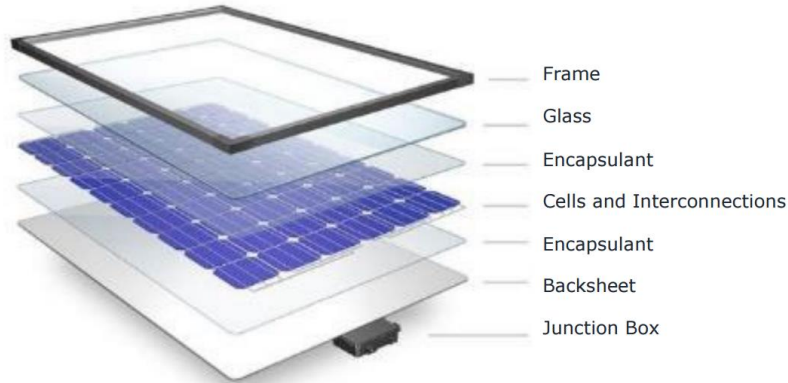
- Electrical Isolation
- Mechanical Stability
- Moisture/O₂ Barrier
- Optical Coupling
- UV Filtering
- 80% of modules show delamination < 15 years [1]!



The Lamination Process



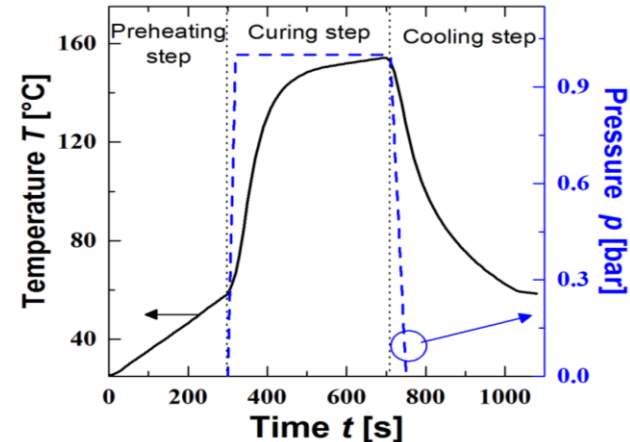
The Lamination Process



Lamination "recipe" $f(T, p, t)$:

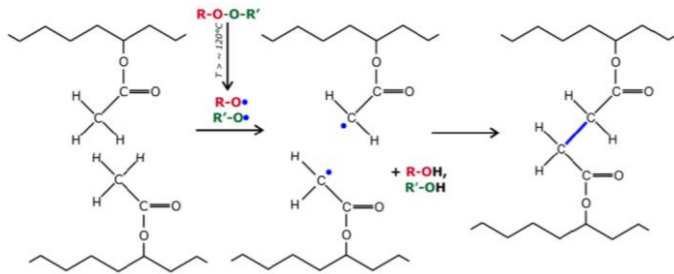
- Specific to the individual material (about 20 min)

- 1. Pre-heating Step:** Upper and lower chamber are evacuated
→ Air removal to minimize fooid formation
→ Softening the encapsulant
- 2. Curing Step:** Heating
→ enhancing adhesion, cross-linking reaction (gel content >80%)
- 3. Cooling Step:** Cool to RT



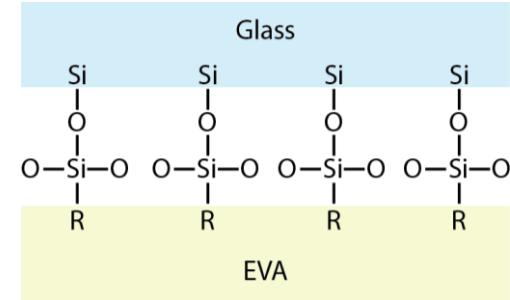
Crosslinking

→ Mechanical stability, transparency



Adhesion

→ Siloxane Bonding



Characterization Techniques:

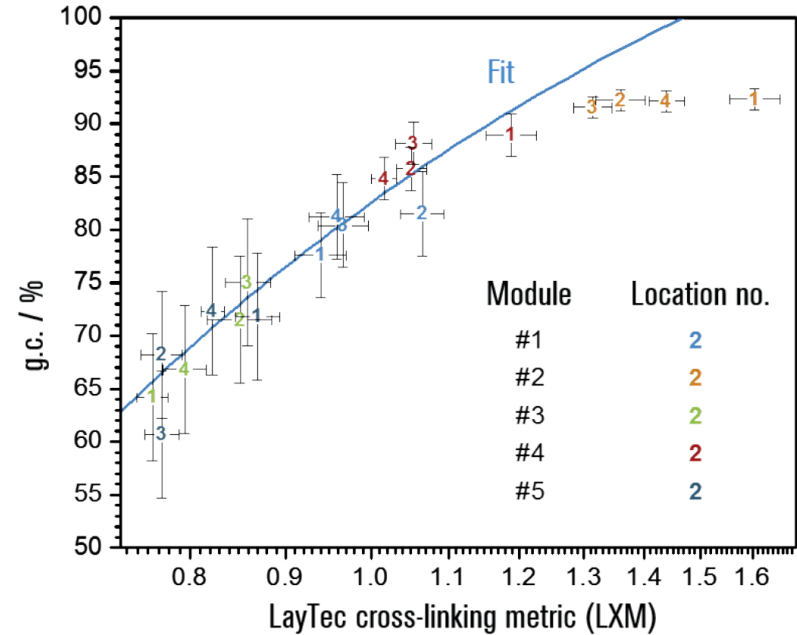
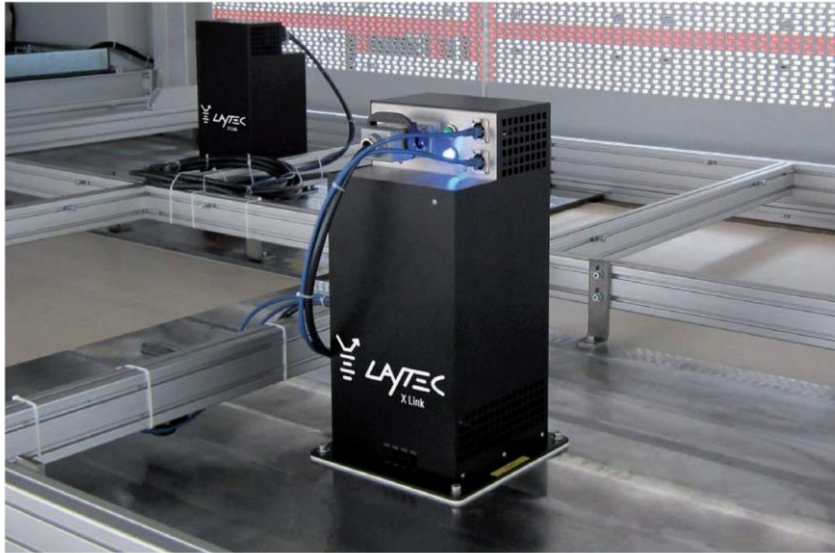
Differential Scanning Calorimetry (DSC),
Soxhlet Extraction

Characterization Techniques:

Peel Test, Single-Cantilever Beam Test

These are destructive methods!

→ Not suited for production / field testing

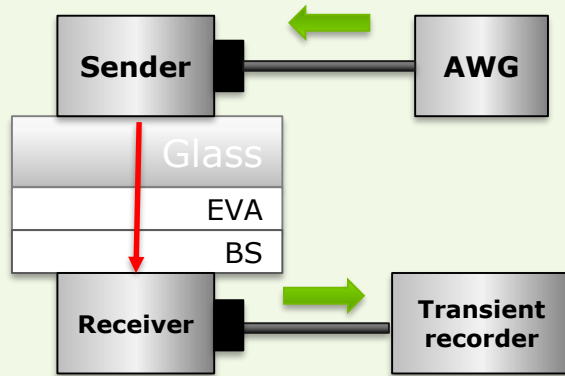


- Uses indentation analysis to probe EVA from the backside
→ not suited for Glass/Glass-Modules

Crosslinking

→ Mechanical stability, transparency

Volume wave transmission method (1)



Longitudinal wave transmission (red) through the sample

Adhesion

→ Siloxane Bonding

High-frequency Lamb wave method (2)

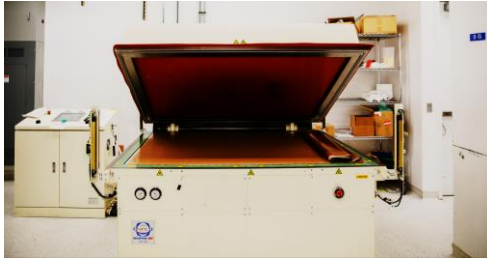


Leaky Lamb wave transport consisting of longitudinal (red) & transversal (blue) partial waves

Crosslinking – Characterization Procedure

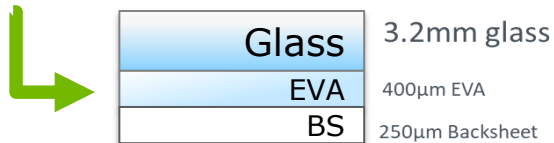
Sample Fabrication

Variation of Lamination Profile



<https://cores.research.asu.edu/solar-fab/equipment/44-npc-laminator>

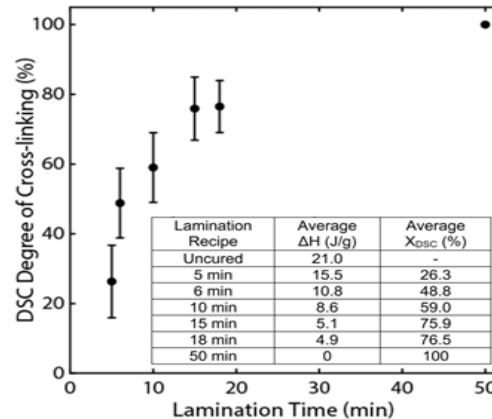
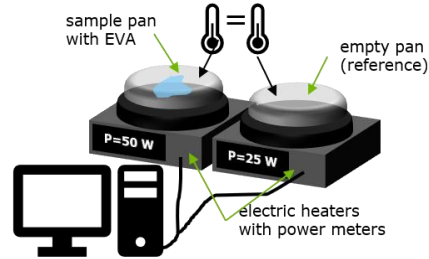
Sample	Vacuum Time [min]	Initial Press [min]	Bladder Pressure [kPa]	Final Press [min]
5 min	4.5	1.5	96	5
6 min				6
10 min				10
15 min				15
18 min				18
50 min				50



Conventional Characterization

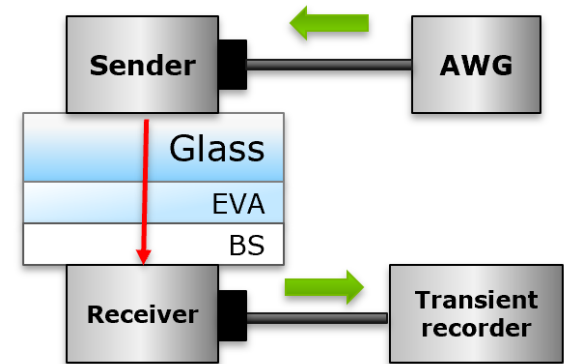
Differential Scanning Calorimetry

Heating both pans with constant temperature ramp (10 K/min)

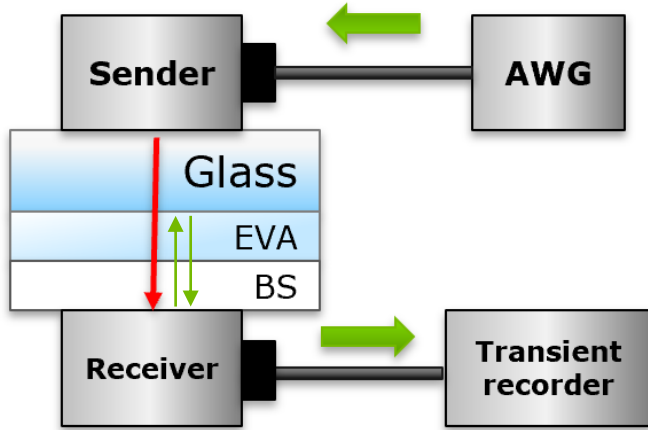


US-Characterization

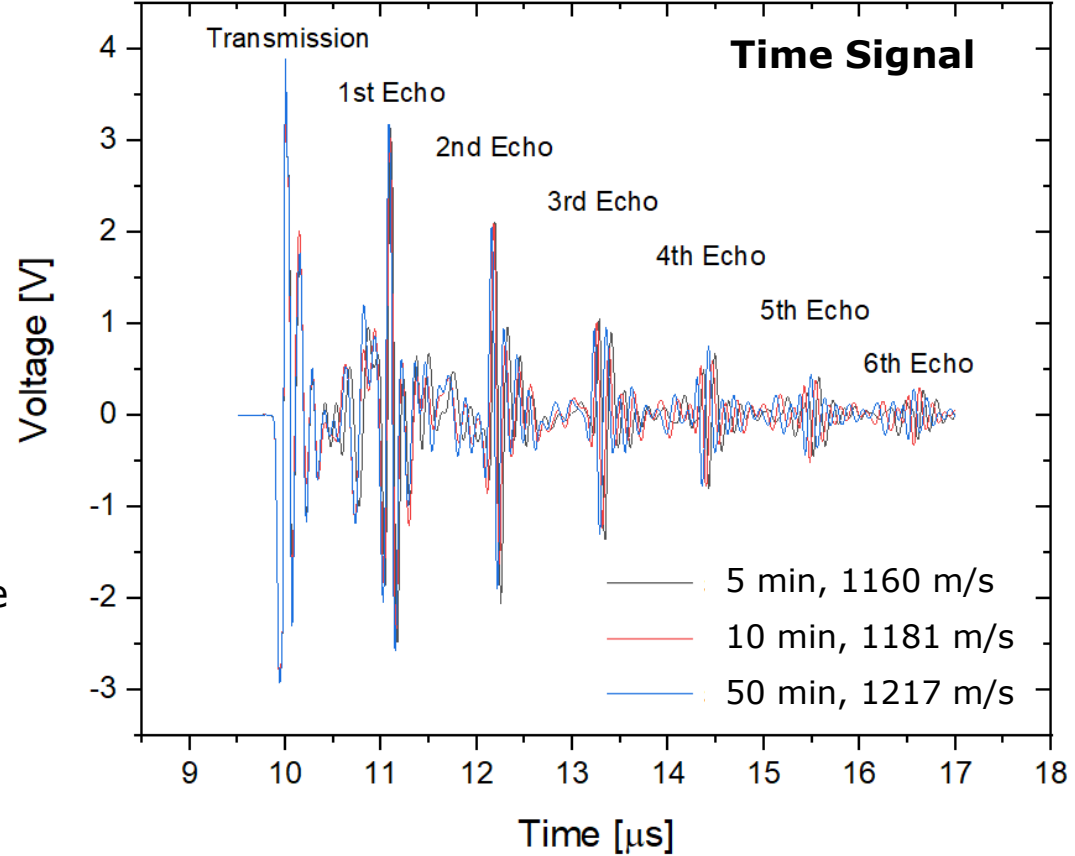
Longitudinal wave speed and attenuation



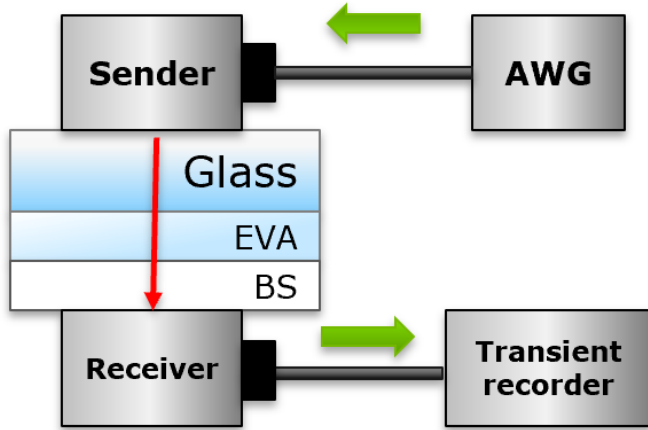
Crosslinking Analysis: US Transmission



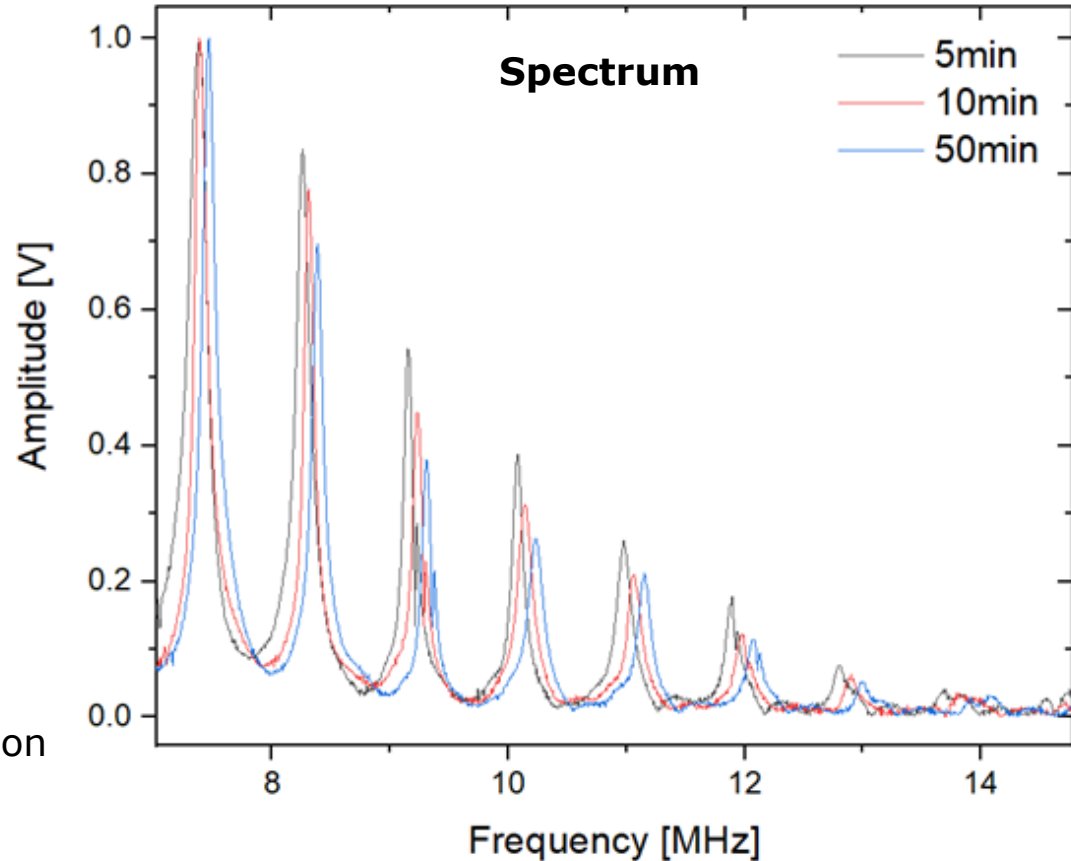
- Decrease in ToF with lamination time
→ (1) increase in elastic modulus
or (2) reduction in thickness

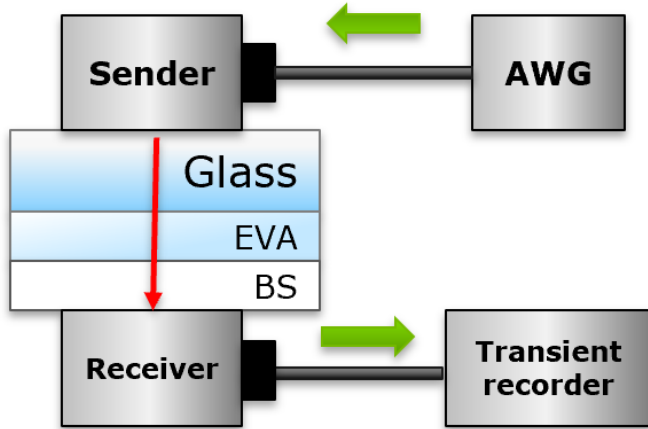


Crosslinking Analysis: US Transmission



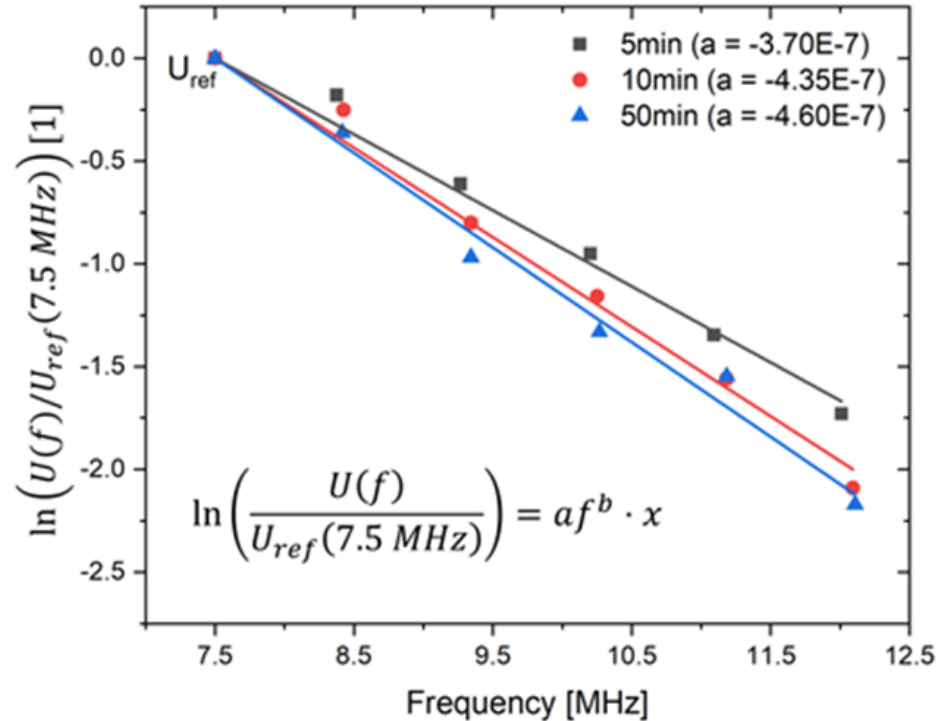
- Increase in Eigenfrequency
→ (1) increase in elastic modulus
or (2) reduction in thickness
- Increase in high-frequency attenuation
→ change in EVA properties

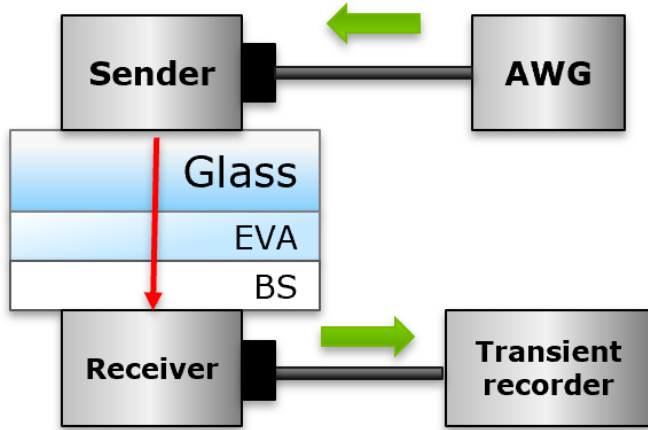




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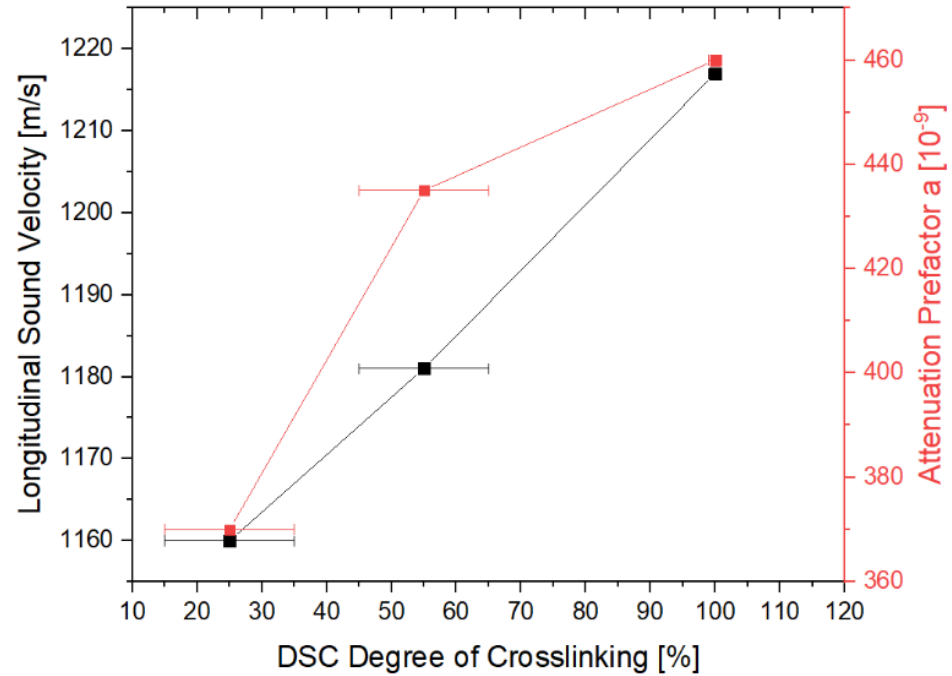
Spectrum





- Calibration of the model by conventional methods for each specific EVA
→ Once calibrated, methods provide non-destructive addition/alternative

Summary

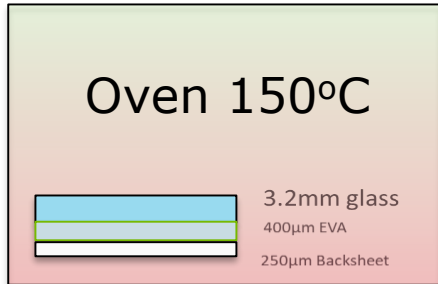


Control measurement: Crosslinking in an Oven

- No lamination pressure
- Same sample measured after different curing durations } const. thickness

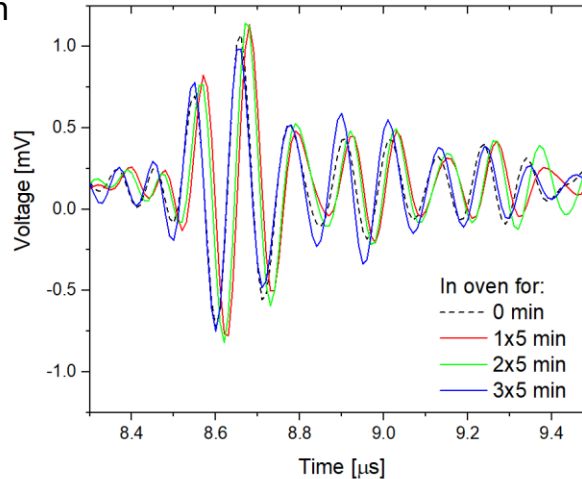
2min laminated sample:

- multiple 5min intervals in oven for sequential crosslinking

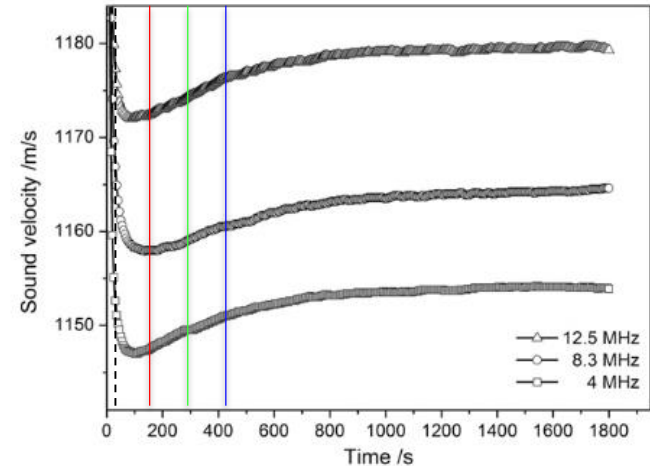


5 min oven \approx 2min > 140°C

Time Signal



Comparison with Literature [1]

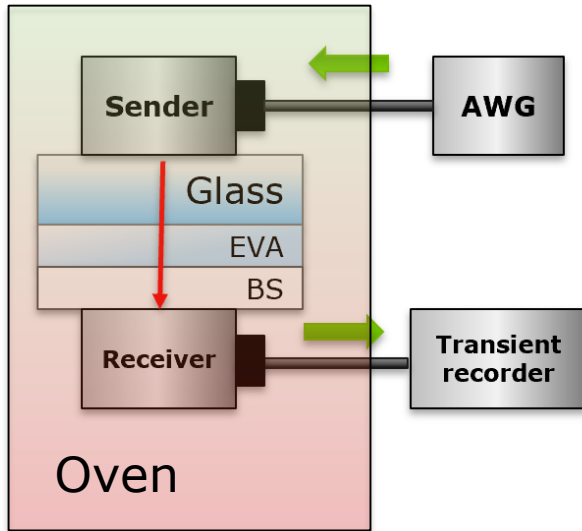


→ After initial drop, sound velocity increases with lamination time

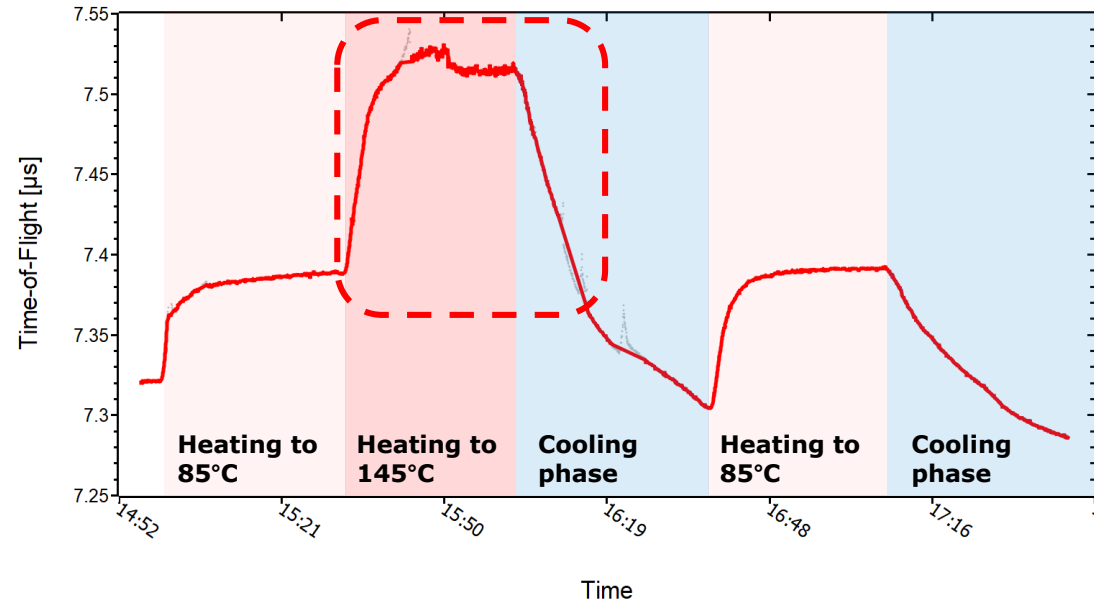
Transmission measurement during Crosslinking Process

Setup modifications:

- thin, high temperature transducer (1.5 mm, up to 200°C)
- Measurement during crosslinking process

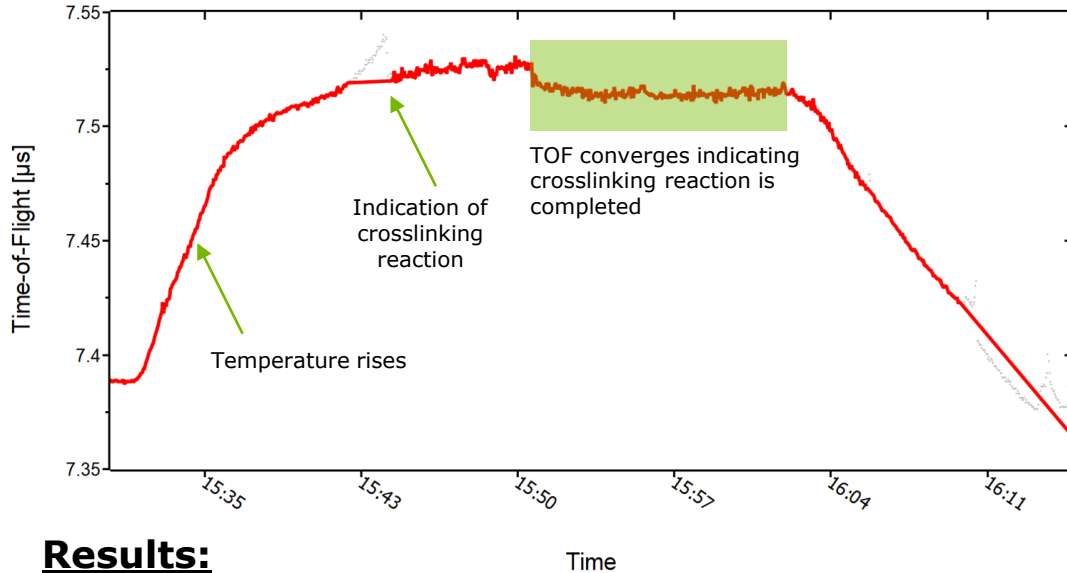


Measurement Results

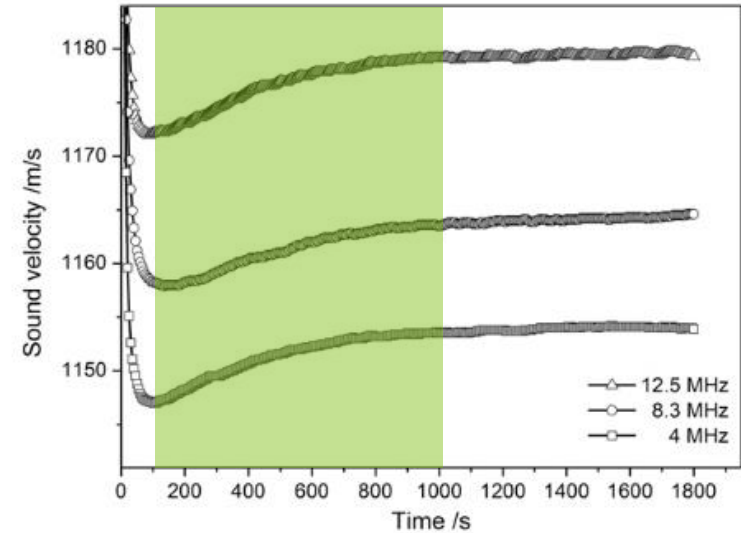


Transmission measurement during Crosslinking Process

Heating step to 145°C



Comparison with Literature [1]



Results:

- Elastic constants (sound velocities) are highly temperature dependent
- Changes due to crosslinking are small in comparison (around 16 ns)
- Crosslinking reaction alters ultrasonic signal → adds noise (to cross-correlation result)
- Crosslinking reaction first increases than decreases ToF (as reported in literature)
- ToF plateaus after 15 min → indicates that crosslinking is completed

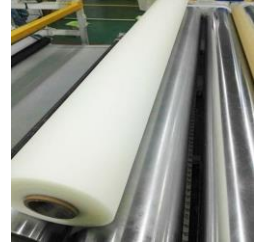
- Effects of environment and aging have not been investigated (yet!)
→ Ideal for non-destructive EVA characterization in module production:

a) **EVA quality inspection:**

- previous aging or pre-crosslinking

b) **Optimization of lamination process parameter:**

- crosslinking analysis (optimization of lamination duration)

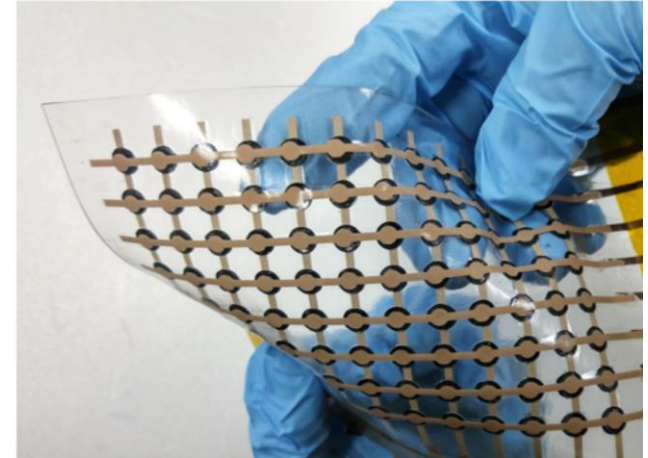
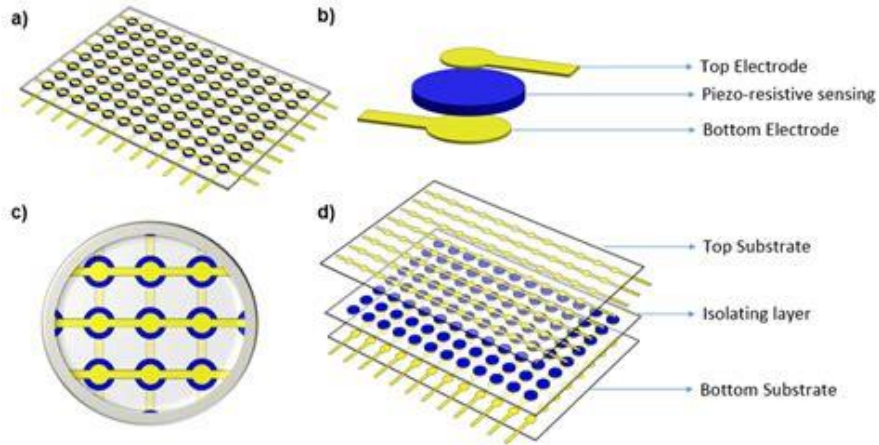


→ **After automation/process integration:**

**Non-destructive EVA characterization of ALL manufactured modules
(instead of sequential destructive testing)**

Next Steps

- **Industrial Prototype**
 - Sensor-array for measuring different module locations at once



Next Steps

- **Follow-up project:**

- Aging of solar modules in the field → ultrasonic sensor for degradation characterization

Goal: to expand the method to evaluate module health

- during field and accelerated aging (temperature, humidity, UV, stress)
- incorporating different encapsulants (EVA, POE) and backsheets

The ultimate goal is a module polymer degradation model based on ultrasonic measurables enabling an estimation of the remaining module's lifetime.

Acoustic Fingerprint



- Volumen- und Lambwellen
 - Schallgeschwindigkeiten(f)
 - Dämpfungseigenschaften(f)

Next Steps

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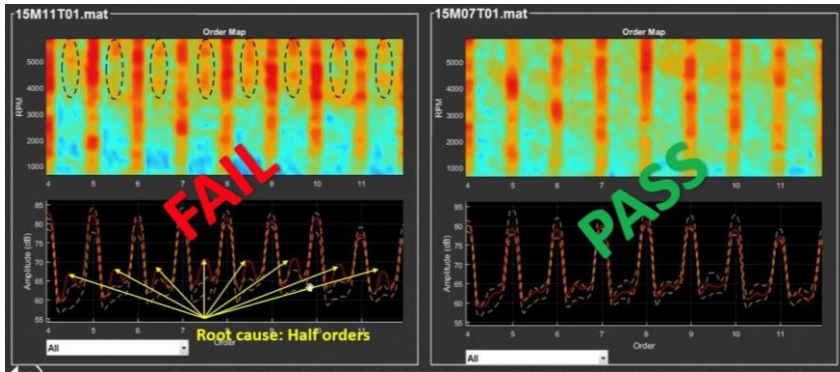
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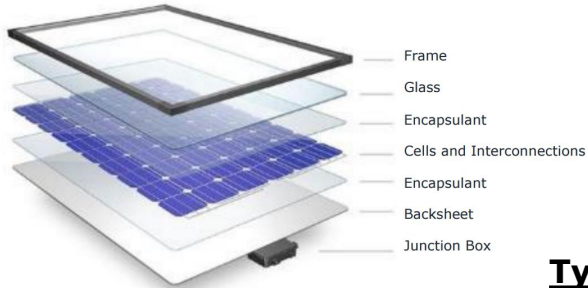
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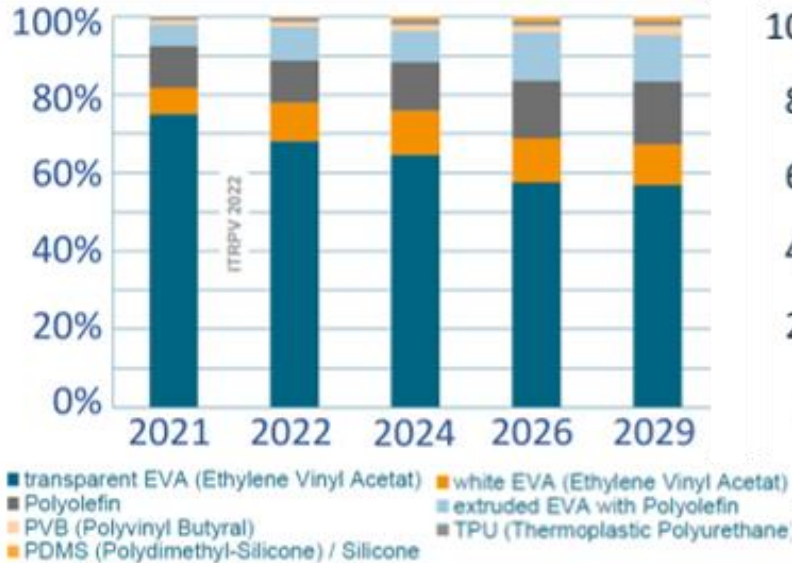
Acoustic Fingerprint



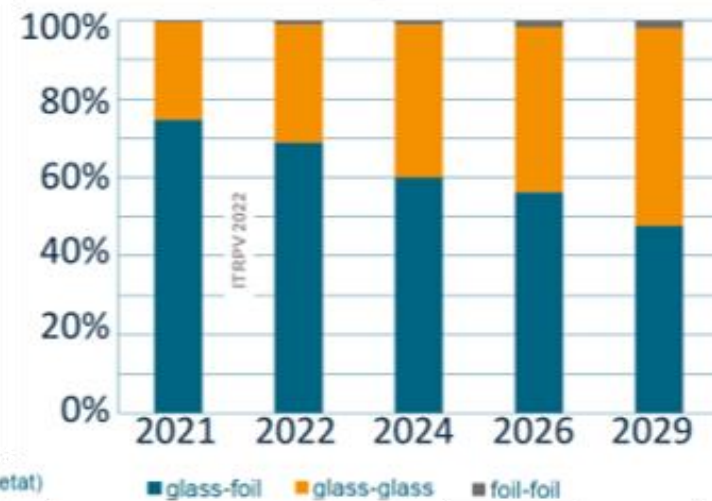
The Solar Module



Types of Encapsulants



Glass-Glass vs. Glass-Backsheet





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